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CONFIRMATION NO. 8607

<b>SERIAL NUMBER</b> 10/085,313	<b>FILING OR 371(c) DATE</b> 02/28/2002 <b>RULE</b>	<b>CLASS</b> 156	<b>GROUP ART UNIT</b> 1733	<b>ATTORNEY DOCKET NO.</b> END920010053US1
<b>APPLICANTS</b> Michael Gaynes, Vestal, NY; William R. Hill, Binghamton, NY;				
<b>** CONTINUING DATA *****</b> This application is a CIP of 09/757,185 01/09/2001, now U.S. Patent 6,719,871 which is a DIV of 09/248,341 02/11/1999 PAT 6,206,997				
<b>** FOREIGN APPLICATIONS *****</b> none - JTH				
<b>IF REQUIRED, FOREIGN FILING LICENSE GRANTED</b> <b>** 03/16/2002</b>				
Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no 35 USC 119 (a-d) conditions <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after met Verified and Acknowledged <input type="checkbox"/> yes <input checked="" type="checkbox"/> no	Allowance Examiner's Signature <i>JTH</i> Initials <i>JTH</i>	<b>STATE OR COUNTRY</b> NY	<b>SHEETS DRAWING</b> 3	<b>TOTAL CLAIMS</b> 21
<b>INDEPENDENT CLAIMS</b> 3				
<b>ADDRESS</b> William H. Steinberg IBM Corporation Dept. IQ0A/Bldg. 40-3 1701 North Street Endicott, NY 13760				
<b>TITLE</b> Method for bonding heat sinks to overmold material				
<b>FILING FEE RECEIVED</b> 758	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue ) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit	